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Product group:

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Heatsinks for LEDs / **ICK LED R 32 x 14 G**   



Ø 32 x 14 mm, for IC design LED

Parameters of article ICK LED R 32 x 14 G

R_{th} [K/W]	 15.23
dissipation loss [W]	 7.6
mounting method	therm. conductive foil / therm. cond. adhesive
socket	universal
suitable for processor type	universal
Ø [mm]	 32
height [mm]	14
plate thickness [mm]	2.5
surface treatment	black anodised

[Technical Drawing](#)

Accessories/ related articles

Thermally conductive foil both sides adhesive / **WLFT 404 D 32**

Thermally conductive foil both sides adhesive / **WLFT 405 D 32**

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